<u>MOSFET</u> – Power, Dual N-Channel 60 V, 36 mΩ, 24 A

Features

- Small Footprint (5x6 mm) for Compact Designs
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- 175°C Operating Temperature
- NVMFD5483NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- This is a Pb–Free Device

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady State	T _C = 25°C	Ι _D	24	А
Current R _{θJC} (Notes 1, 2, 4)		$T_{\rm C} = 100^{\circ}{\rm C}$		17	
Power Dissipation $R_{\theta JC}$ (Notes 1, 2)		$T_{C} = 25^{\circ}C$	PD	44.1	W
		T _C = 100°C		22.1	
Continuous Drain		T _A = 25°C	Ι _D	6.4	А
Current R _{θJA} (Notes 1, 3 & 4)	Steady State	T _A = 100°C		4.5	
Power Dissipation $R_{\theta JA}$ (Notes 1 & 3)		T _A = 25°C	PD	3.1	W
		T _A = 100°C		1.5	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	153	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 175	°C
Source Current (Body Diode)			۱ _S	39	А
Single Pulse Drain-to–Source Avalanche Energy (T _J = 25°C, V _{GS} = 10 V, I _{L(pk)} = 28 A, L = 0.1 mH)			E _{AS}	39	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	3.4	°C/W
Junction-to-Ambient - Steady State (Note 3)	R _{0.IA}	49	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted to an ideal (infinite) heat sink.

3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

4. Maximum current for pulses as long as 1 second are higher but are dependent on pulse duration and duty cycle.

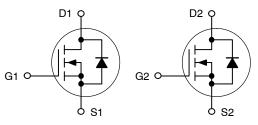


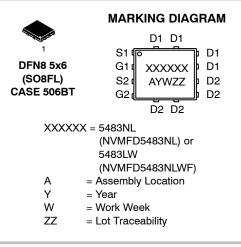
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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
60 V	36 mΩ @ 10 V	24 A
00 V	45 mΩ @ 4.5 V	247







ORDERING INFORMATION

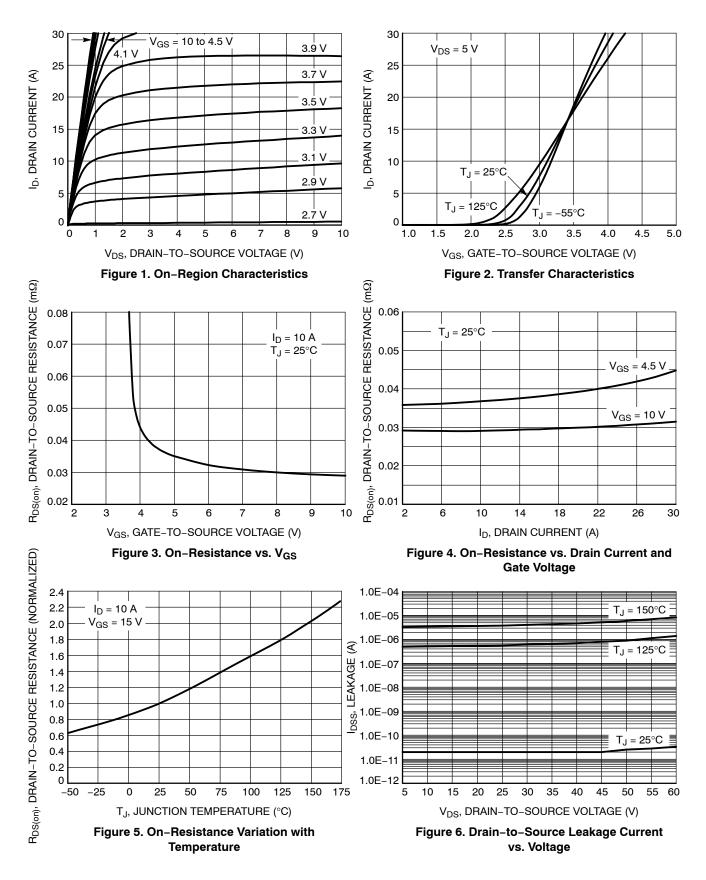
Device	Package	Shipping [†]			
NVMFD5483NLT1G	DFN8 (Pb-Free)	1500/ Tape & Reel			
NVMFD5483NLT3G	DFN8 (Pb-Free)	5000/ Tape & Reel			
NVMFD5483NLWFT1G	DFN8 (Pb–Free)	1500/ Tape & Reel			
NVMFD5483NLWFT3G	DFN8 (Pb–Free)	5000/ Tape & Reel			

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

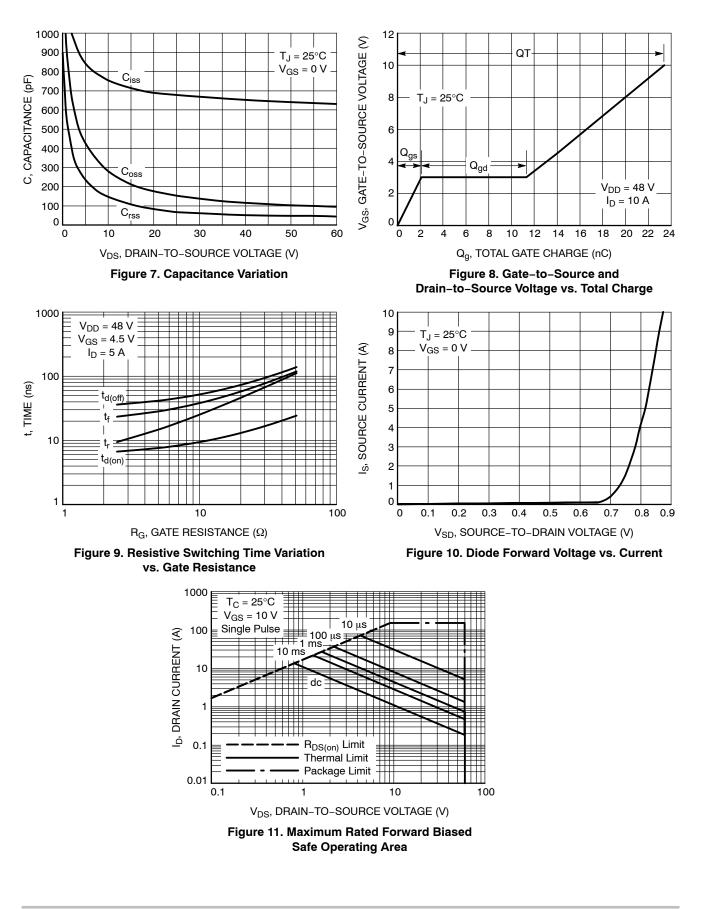
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	•				-	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	Reference to I _D = 250 μ			63		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	$T_J = 25^{\circ}C$			1.0	μΑ
			$T_J = 125^{\circ}C$			10	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D =	250 μA	1.5		2.5	V
Gate Threshold Voltage Temperature Coefficient	V _{GS(TH)} /T _J	Reference to 25°C $I_D = 250 \ \mu A$			-5.2		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D	= 15 A		29	36	mΩ
	. ,	V _{GS} = 4.5 V, I _D = 15 A			36	45	
CHARGES AND CAPACITANCES	•	•				-	•
Input Capacitance	C _{iss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 25 V			668	[pF
Output Capacitance	C _{oss}				152		
Reverse Transfer Capacitance	C _{rss}				67		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 10 \text{ V}, V_{DS} = 48 \text{ V},$ $I_D = 10 \text{ A}$			23.4		nC
Threshold Gate Charge	Q _{G(TH)}				0.65		
Gate-to-Source Charge	Q _{GS}				2.14		
Gate-to-Drain Charge	Q _{GD}		ľ		9.16		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 48 V, I_{D} = 10 A			13.2		nC
SWITCHING CHARACTERISTICS (No	ote 6)	•					•
Turn-On Delay Time	t _{d(on)}				6.8		ns
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS}	s = 48 V.		10.3		
Turn-Off Delay Time	t _{d(off)}	$I_{\rm D} = 5.0 \text{ A}, R_{\rm G} = 2.5 \Omega$			37.5		
Fall Time	t _f				23.5		1
DRAIN-SOURCE DIODE CHARACTE	RISTICS				•		
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	T _J = 25°C		0.87	1.2	V
		$I_{\rm S} = 10 \rm A$	T _J = 125°C		0.82	1	1
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, d _{IS} /d _t = 100 A/µs, I _S = 10 A			30		ns
Charge Time	ta				23.3	1	1
Discharge Time	t _b				6.7	1	1
Reverse Recovery Charge	Q _{RR}				35	1	nC

5. Pulse Test: pulse width = 300 μs, duty cycle ≤ 2%.
6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



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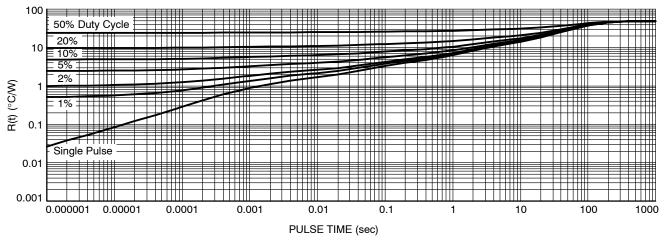
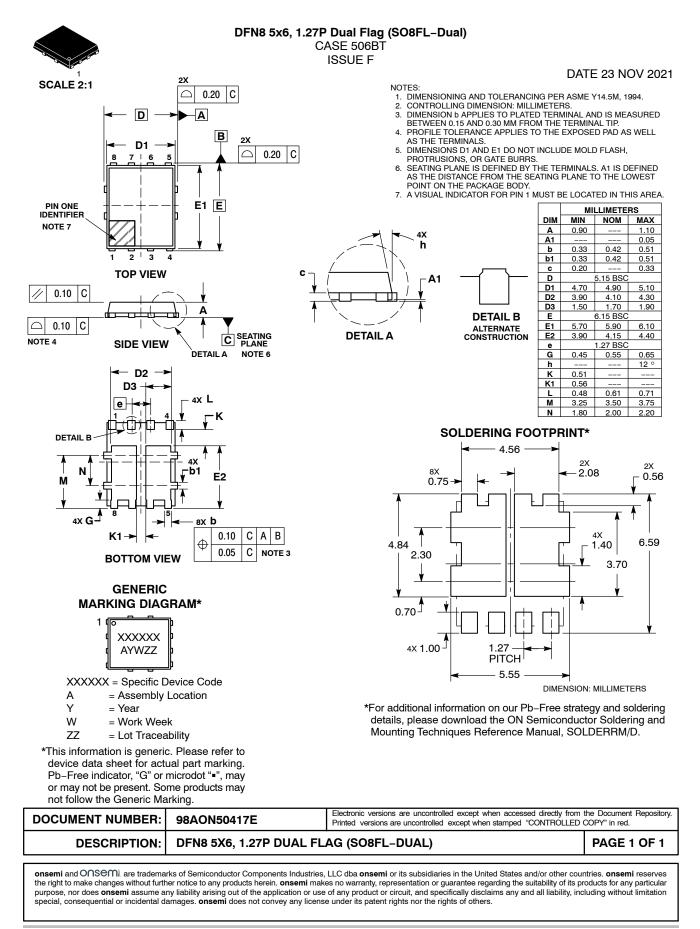


Figure 12. Thermal Response

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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